

N-Channel 200-V (D-S) MOSFET

PRODUCT SUMMARY		
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)
200	0.130 at V _{GS} = 10 V	3
	0.142 at V _{GS} = 6.0 V	2.8

FEATURES

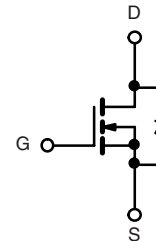
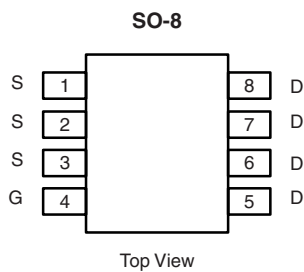
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_g Tested



RoHS
COMPLIANT
HALOGEN
FREE
Available

APPLICATIONS

- Primary Side Switch



N-Channel MOSFET

Ordering Information: Si4418DY-T1-E3 (Lead (Pb)-free)
Si4418DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter	Symbol	10 s	Steady State	Unit	
Drain-Source Voltage	V _{DS}	200		V	
Gate-Source Voltage	V _{GS}	± 20			
Continuous Drain Current (T _J = 150 °C) ^a	I _D	T _A = 25 °C	3	2.3	A
		T _A = 85 °C	2.1	1.6	
Pulsed Drain Current	I _{DM}	12			
Avalanche Current	I _{AS}	6			
Single Avalanche Energy (Duty Cycle ≤ 1 %)	E _{AS}	1.8		mJ	
Continuous Source Current (Diode Conduction) ^a	I _S	2.1	1.25	A	
Maximum Power Dissipation ^a	P _D	T _A = 25 °C	2.5	1.5	W
		T _A = 85 °C	1.3	0.8	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	R _{thJA}	t ≤ 10 s	36	50	°C/W
		Steady State	71	85	
Maximum Junction-to-Foot (Drain)	R _{thJF}	15	20		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

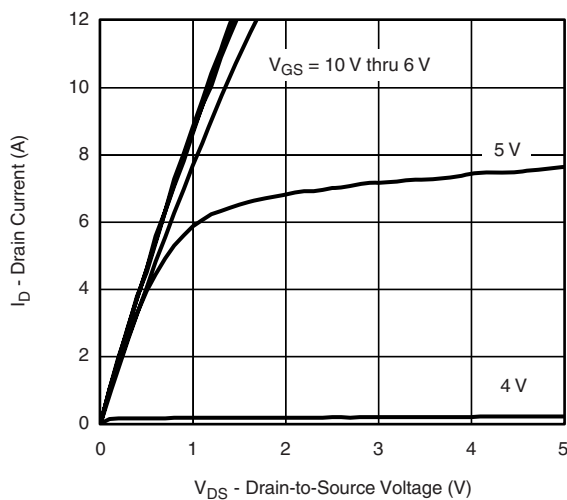
SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2		4	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 85^\circ\text{C}$			20	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5 \text{ V}, V_{GS} = 10 \text{ V}$	12			A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = 10 \text{ V}, I_D = 3 \text{ A}$		0.110	0.130	Ω
		$V_{GS} = 6.0 \text{ V}, I_D = 2.8 \text{ A}$		0.120	0.142	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15 \text{ V}, I_D = 3 \text{ A}$		13		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.1 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3 \text{ A}$		20	30	nC
Gate-Source Charge	Q_{gs}		4.5			
Gate-Drain Charge	Q_{gd}		6.5			
Gate Resistance	R_g	$f = 1 \text{ MHz}$	1	2	3.4	Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 100 \text{ V}, R_L = 100 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		15	25	ns
Rise Time	t_r		15	25		
Turn-Off Delay Time	$t_{d(off)}$		40	60		
Fall Time	t_f		20	30		
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = 2.1 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$		70	110	

Notes:

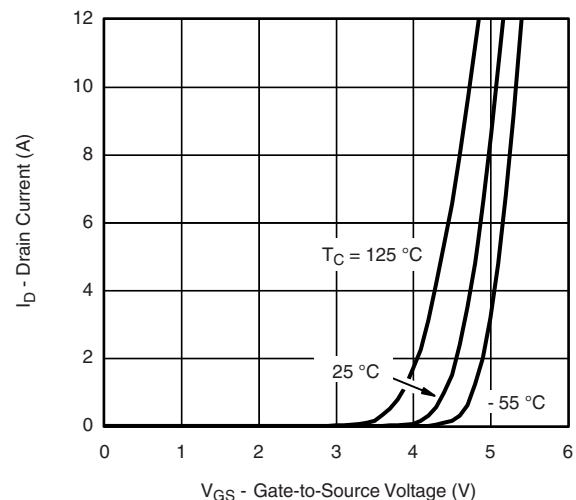
- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25°C , unless otherwise noted

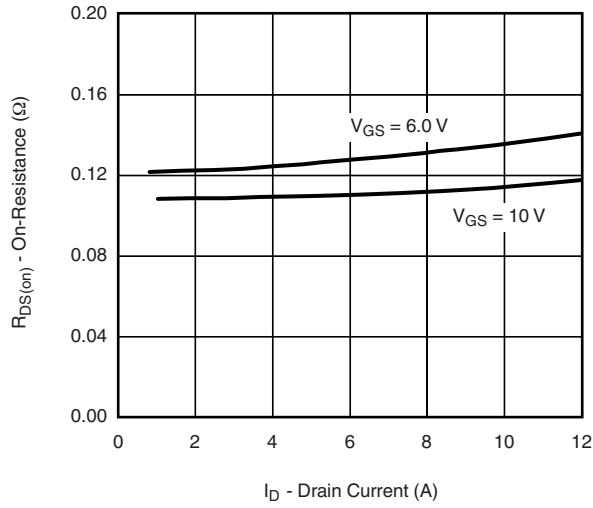


Output Characteristics

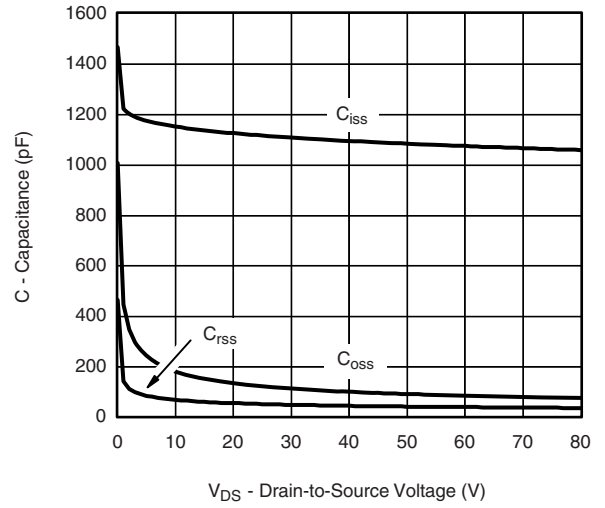


Transfer Characteristics

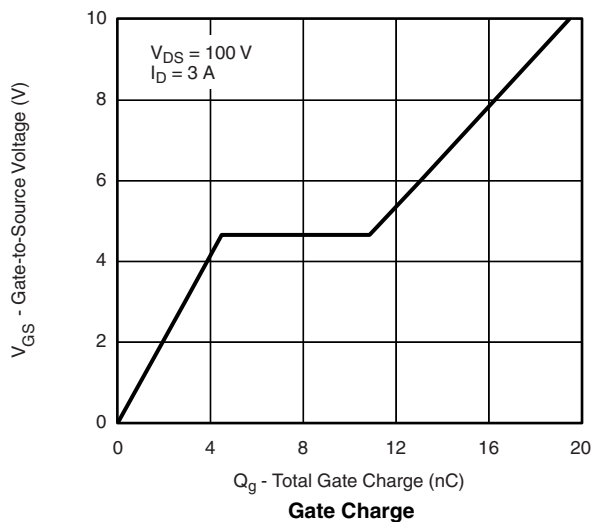
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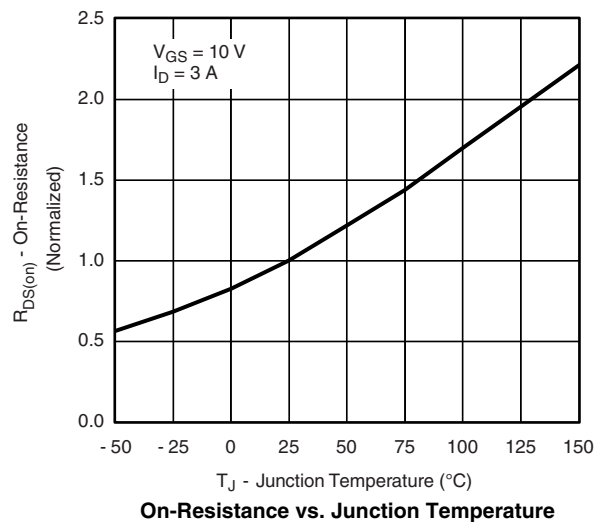
On-Resistance vs. Drain Current



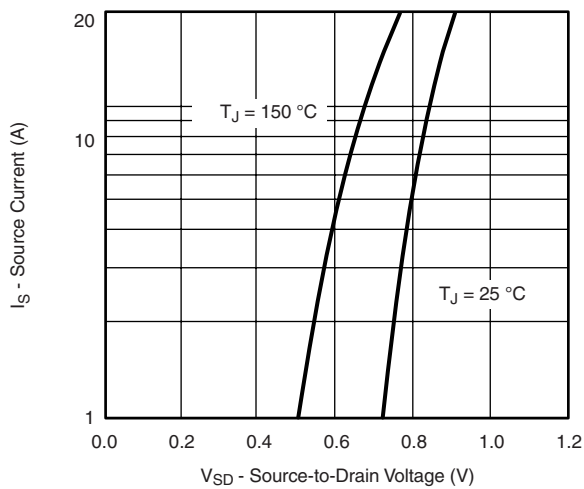
Capacitance



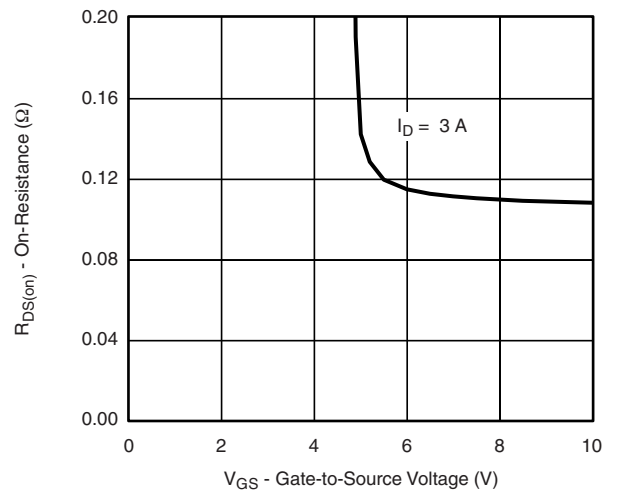
Gate Charge



On-Resistance vs. Junction Temperature

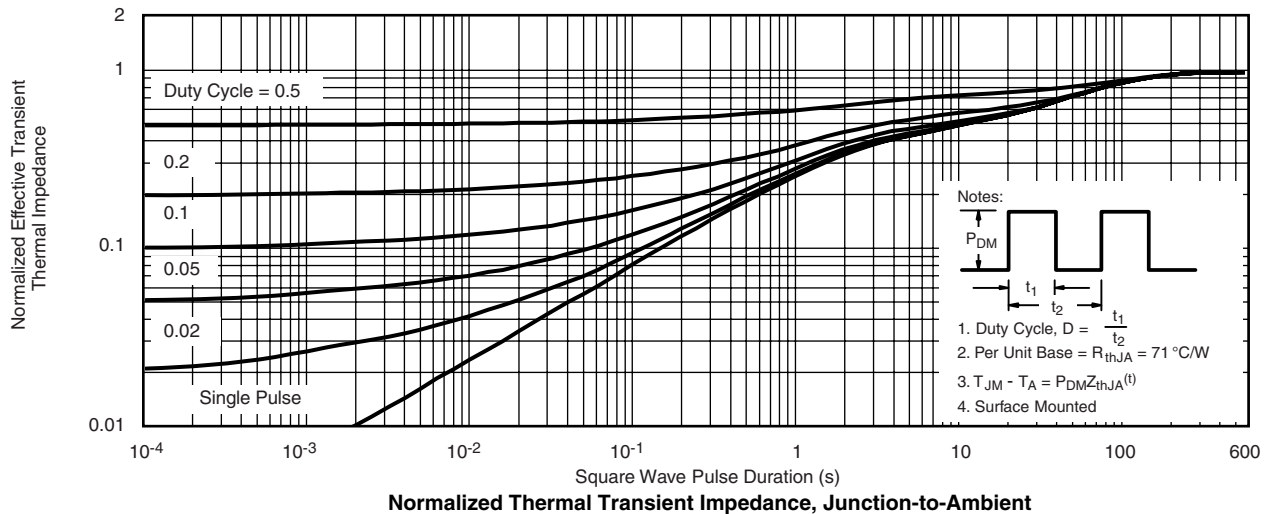
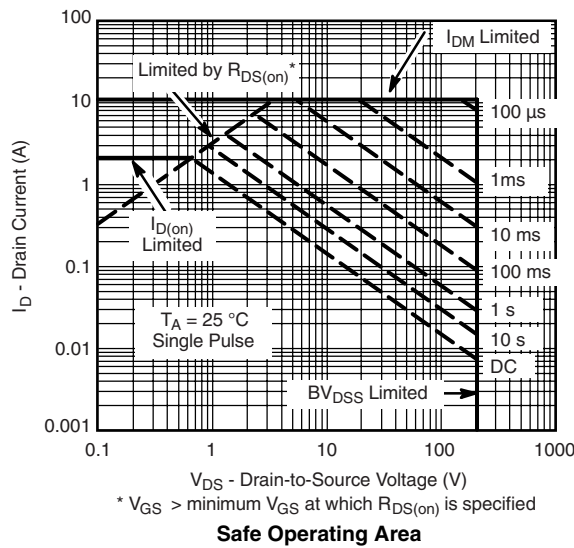
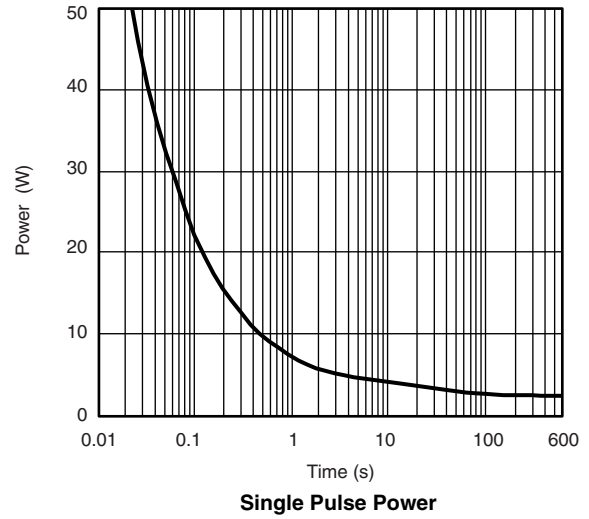
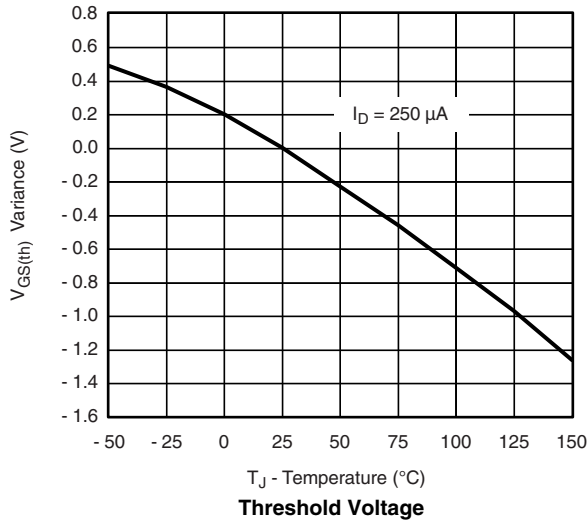


Source-Drain Diode Forward Voltage



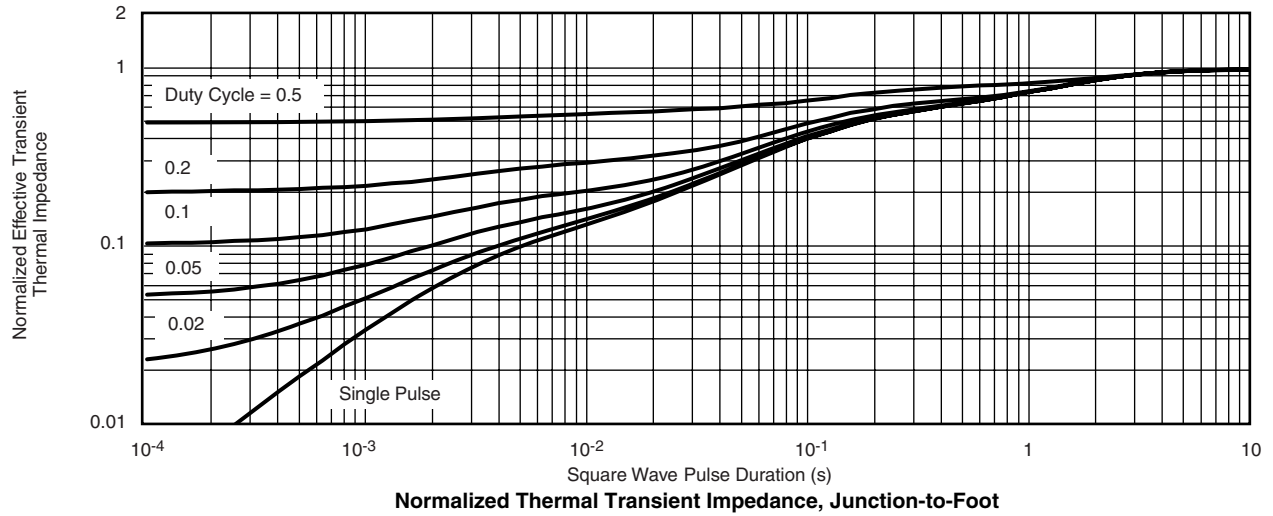
On-Resistance vs. Gate-to-Source Voltage

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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